

C0603X279C2TACTU

Aliases (C0603X279C2TAC7867)

General Information

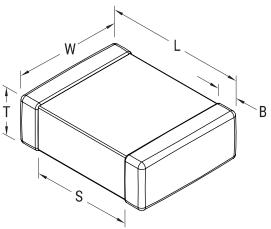
Series

Style

SMD Comm X8G HT150C Flex, Ceramic, 2.7 pF, +/-0.25 pF, 200 VDC, X8G, SMD, MLCC, High Temperature, Ultra-Stable, 0603, 0.4 mm

SMD Comm X8G HT150C Flex

SMD Chip



	Description	SMD, MLCC, High Temperature, Ultra-Stable
S	Features	High Temperature, Ultra-Stable
	RoHS	Yes
	Termination	Flexible Termination
	Marking	No
	AEC-Q200	No
	Typical Component Weight	4.6 mg
Click here for the 3D model.	Shelf Life	78 Weeks
	MSL	1

Dimensions	
Chip Size	0603
L	1.6mm +/-0.17mm
W	0.8mm +/-0.15mm
Т	0.8mm +/-0.15mm
S	0.4mm MIN
В	0.45mm +/-0.15mm

Packaging Specifications	
Packaging	T&R, 180mm, Paper Tape
Packaging Quantity	4000

Specifications	
Capacitance	2.7 pF
Measurement Condition	1 MHz 1.0Vrms
Tolerance	+/-0.25 pF
Voltage DC	200 VDC
Dielectric Withstanding Voltage	500 VDC
Temperature Range	-55/+150°C
Temp. Coefficient	X8G
Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC)	30 ppm/C, 1MegaHz 1.0Vrms
Dissipation Factor	0.1% 1 MHz 1.0Vrms
Aging Rate	0% Loss/Decade Hour: Referee Time is 1000 Hours
Insulation Resistance	100 GOhms

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